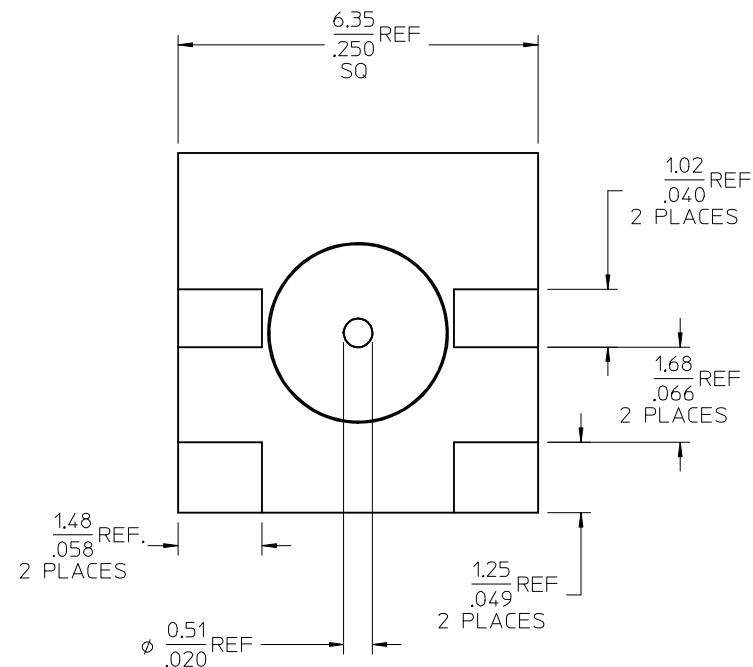
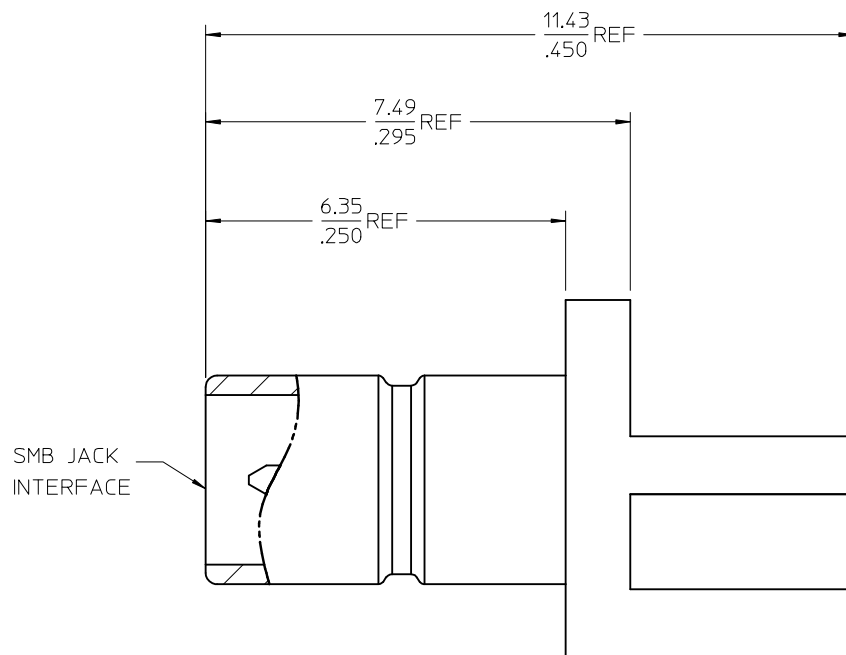
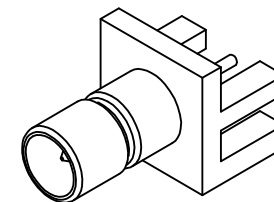


MATERIALS AND FINISHES:

BODY BRASS
PLATED GOLD (SEE PART NUMBER DESCRIPTION)

CONTACT BRASS
PLATED GOLD (30 MICROINCHES MIN) 73404-0300
PLATED GOLD (20 MICROINCHES MIN) 73404-0301

INSULATOR TEFLON



ES-89675-3040	INTERFACE
PS-89675-2000	ELECTRO/MECH PERFORM.
SPECIFICATION	DESCRIPTION

73404-0301	3-5 MICROINCHES MIN.
73404-0300	30 MICROINCHES MIN.
PART NUMBER	BODY GOLD PLATING

ADDED DIM.
PER RF14-E036
EC NO: URF2014-0138
DRWN:LIN 2013/08/27
CHKD:
APPR:MHUANG 2013/09/04
REV

QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
▼=0 ▽=0	mm INCH	MM/IN	METRIC		
4 PLACES ± --- ± ---	DRAWN BY DATE	TITLE	MOLEX INCORPORATED SMB JACK, 75 OHMS AIR DIELECTRIC, EDGE MOUNT SMB-J/PCB		
3 PLACES ± --- ± ---	CHECKED BY DATE				
2 PLACES ± --- ± ---	SSS DATE				
1 PLACE ± --- ± ---	APPROVED BY DATE				
ANGULAR ± 2 °	MATERIAL NO.	DOCUMENT NO.			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	SIZE	SEE TABLE	SD-73404-030		
		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	SHEET NO. 1 OF 1		